



ON Semiconductor®

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LV5011MD

Bi-CMOS LSI

LED Driver IC

Overview

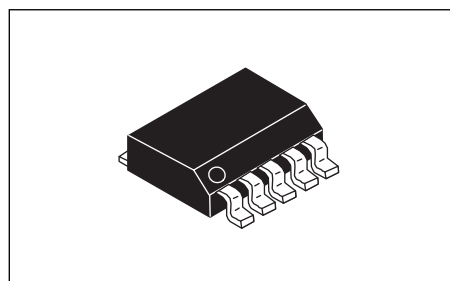
LV5011MD is a High Voltage LED driver with internal power FET.

LV5011MD is realized very simple LED circuits with a few external parts. It corresponds to various wide dimming controls including the TRIAC dimming control.

Note) This LV5011MD is designed or developed for general use or consumer appliance. Therefore, it is NOT permitted to use for automotive, communication, office equipment, and industrial equipment.

Function

- High Voltage LED Driver
- Built-in output power FET
- Built-in TRIAC stabilized function
- Various Dimming Control
 - TRIAC & Analog Input
- Selectable reference Voltage
 - Internal 0.605V & External Input Voltage
- Over Voltage Protection
- Short Protection Circuit



SOIC-10 NB

Specifications

Maximum Ratings at Ta = 25°C

| Parameter | Symbol | Conditions | Ratings | unit |
|--------------------------------|-----------------------------|-------------------------|-------------|------|
| Maximum Input voltage | V _{IN} max (Note1) | | -0.3 to 42 | V |
| REF_IN, CS, ACS pin | | | -0.3 to 7 | V |
| Drain pin | V _{Drain_abs} | | -0.3 to 600 | V |
| OUT2 pin | V _{OUT2_abs} | | -0.3 to 42 | V |
| Allowable power dissipation | P _d max | With specified board *1 | 0.6 | W |
| Junction temperature | T _j | | 150 | °C |
| Operating Junction temperature | T _{opj} (Note2) | | -30 to +125 | °C |
| Storage temperature | T _{stg} | | -40 to +150 | °C |

*1: Specified board=35mm×16.5mm×1.2mm, glass epoxy board

Note1) Absolute maximum ratings represent the values which cannot be exceeded for any length of time.

Note2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ORDERING INFORMATION

See detailed ordering and shipping information on page 10 of this data sheet.

LV5011MD

Recommended Operating Conditions at Ta = 25°C

| Parameter | Symbol | Conditions | Ratings | Unit |
|---------------|-----------------|------------|-----------|------|
| Input voltage | V _{IN} | | 8.5 to 24 | V |

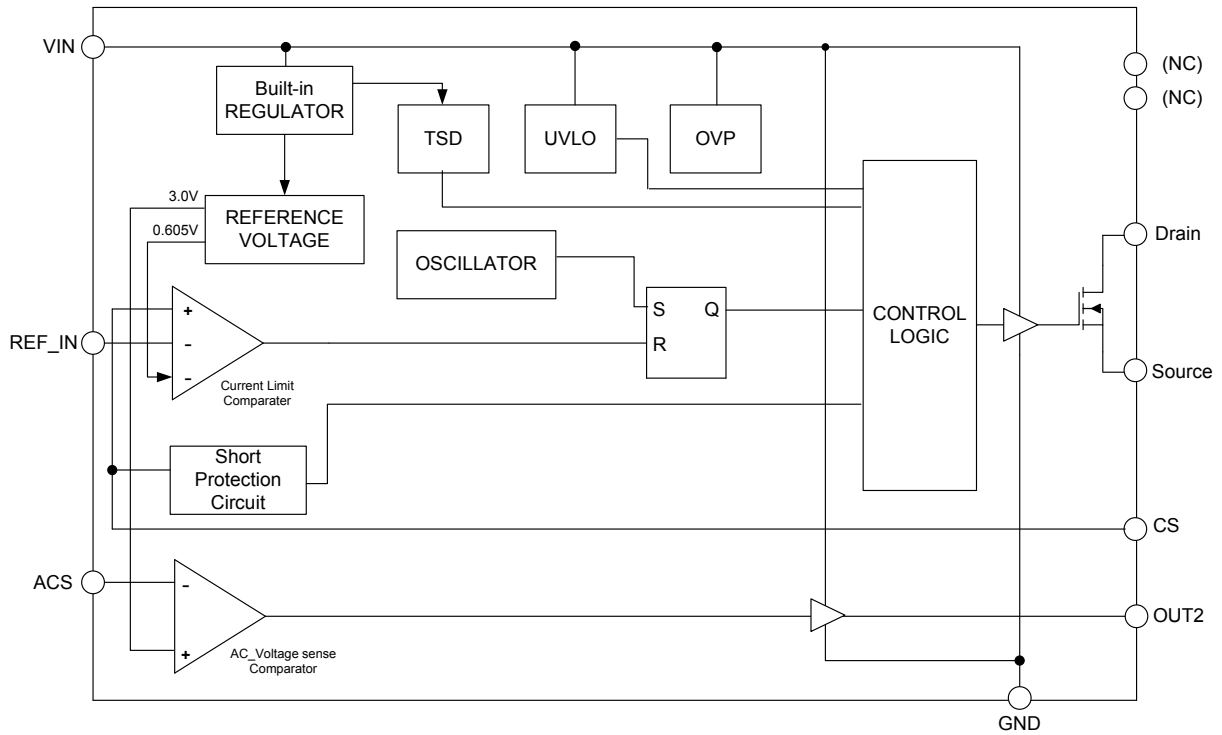
Electrical Characteristics at Ta = 25°C, V_{IN} = 12V, unless otherwise specified.

| Parameter | Symbol | Conditions | Ratings | | | Unit |
|---|---------------------|--------------------------------------|---------|-------|-------|------|
| | | | min | typ | max | |
| Reference Voltage block | | | | | | |
| Built-in Reference Voltage | VREF | | 0.585 | 0.605 | 0.625 | V |
| VREF V _{IN} line regulation | VREF_LN | V _{IN} = 8.5 to 24V | | ±0.5 | | % |
| Under Voltage Lockout | | | | | | |
| Operation Start Input Voltage | UVLOON | | 8 | 9 | 10 | V |
| Operation Stop Input Voltage | UVLOOFF | | 6.3 | 7.3 | 8.3 | V |
| Hysteresis Voltage | UVLOH | | | 1.7 | | V |
| Oscillation | | | | | | |
| Frequency | FOSC | | 55 | 70 | 85 | kHz |
| Maximum ON duty | MAXDuty | | | 93 | | % |
| Comparator | | | | | | |
| Input offset Voltage (Between CS and REF_IN) | V _{IO_RI} | | | 1 | 10 | mV |
| Input current | I _{IOCS} | | | 160 | | nA |
| | I _{IOREF} | | | 80 | | nA |
| CS pin max voltage | VOM | | | | 1 | V |
| FET output stage | | | | | | |
| Drain Leakage current | ILK | V _{Drain} =480V | | | 100 | μA |
| Power FET ON resistor | R _{on} | V _{IN} =12V | | 9.5 | | Ω |
| Minimum On time | T _{MIN} | | | 200 | | ns |
| Thermal protection Circuit | | | | | | |
| Thermal shutdown temperature | TSD | *Design guarantee | | 165 | | °C |
| Thermal shutdown hysteresis | ΔTSD | *Design guarantee | | 30 | | °C |
| TRIAC Stabilization Circuit | | | | | | |
| Threshold of OUT2 | VACS | OUT2=High [less than right record] | 2.8 | 3.0 | 3.2 | V |
| OUT2 sink current | I _{O2I} | V _{IN} =12V, OUT2=6V | | 0.6 | | mA |
| OUT2 source current | I _{O2O} | V _{IN} =12V, OUT2=6V | | 0.6 | | mA |
| V_{CC} current | | | | | | |
| UVLO mode V _{IN} current | I _{CCOFF} | V _{IN} <UVLOOFF | | 120 | 160 | μA |
| Normal mode V _{IN} current | I _{CCON} | V _{IN} =12V | | 1.0 | | mA |
| V_{IN} Over Voltage Protection Circuit | | | | | | |
| V _{IN} over voltage protection voltage | V _{IN} OVP | | 24 | 27 | 30 | V |
| V _{IN} Current at OVP | I _{INOVP} | V _{IN} =30V | 0.7 | 1.0 | 1.5 | mA |
| CS terminal abnormal sensing circuit | | | | | | |
| Abnormal sensing voltage | CSOCP | | | 1.9 | | V |

*: Design guarantee (value guaranteed by design and not tested before shipment)

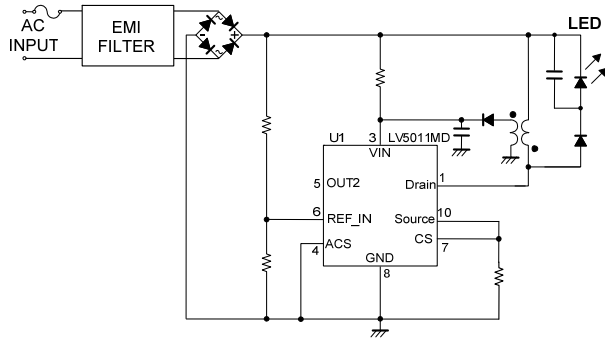
LV5011MD

Block Diagram

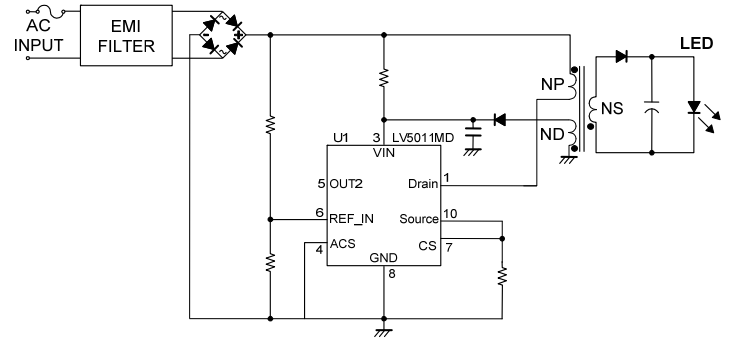


Sample Application Circuit

<Non-isolation>



<Isolation>



LV5011MD

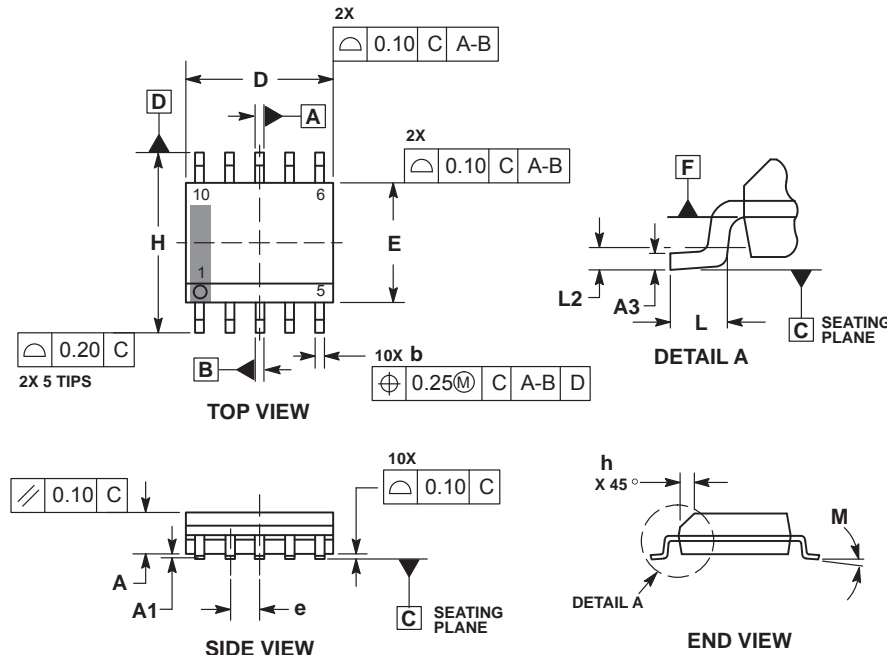
Package Dimensions

unit : mm

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CASE 751BQ- 01

ISSUE A

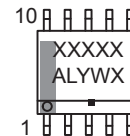


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.10mm TOTAL IN EXCESS OF b AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15mm PER SIDE. DIMENSIONS D AND E ARE DETERMINED AT DATUM F.
5. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM F.
6. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | 1.25 | 1.75 |
| A1 | 0.10 | 0.25 |
| A3 | 0.17 | 0.25 |
| b | 0.31 | 0.51 |
| D | 4.80 | 5.00 |
| E | 3.80 | 4.00 |
| e | 1.00 BSC | |
| H | 5.80 | 6.20 |
| h | 0.37 REF | |
| L | 0.40 | 1.27 |
| L2 | 0.25 BSC | |
| M | 0° | 8° |

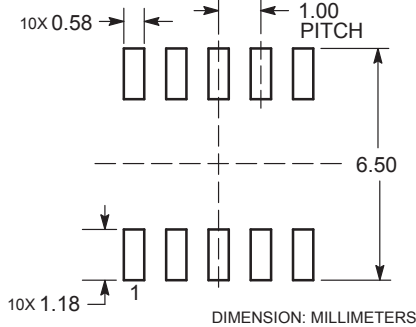
GENERIC MARKING DIAGRAM*



- XXXXX = Specific Device Code
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

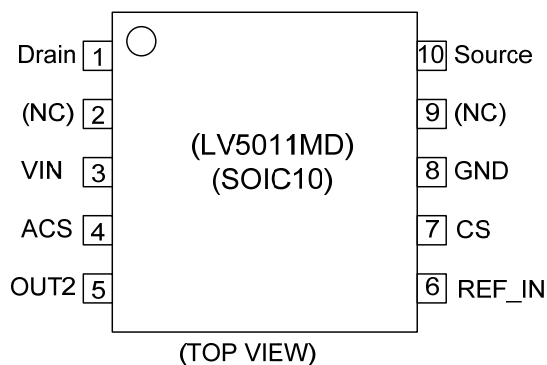
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, G, may or not be present.

RECOMMENDED SOLDERING FOOTPRINT*

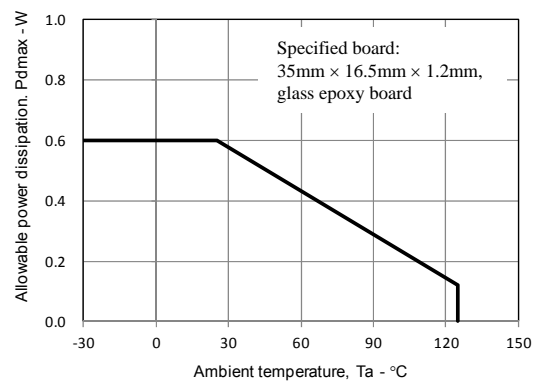


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Pin Assignment



Pd max - Ta

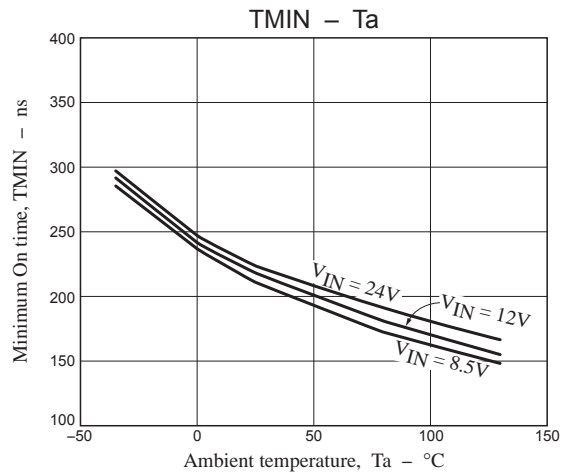
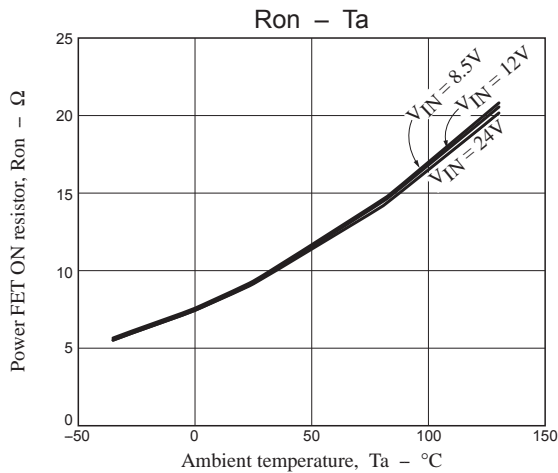
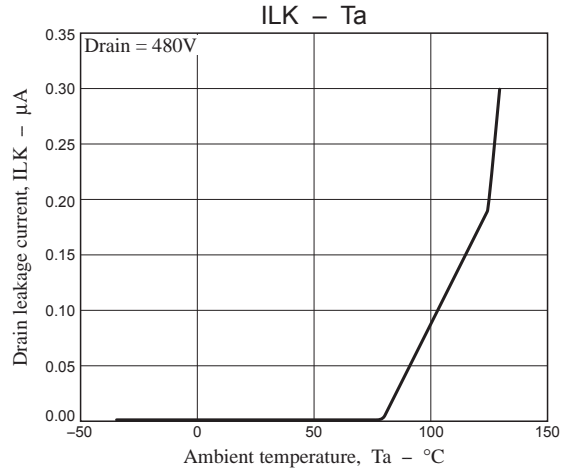
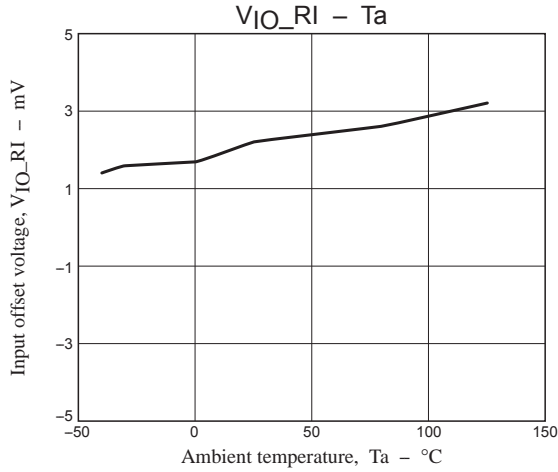
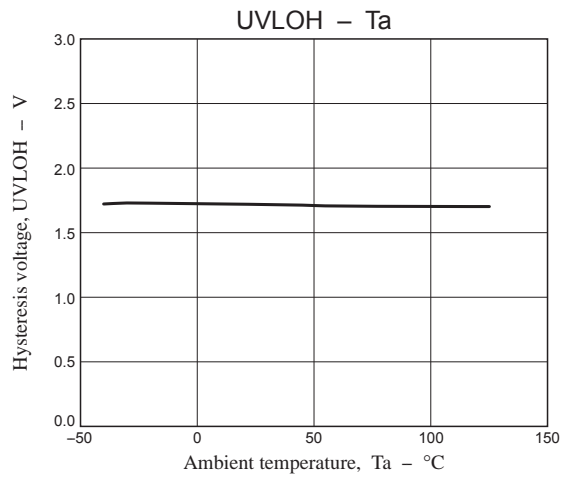
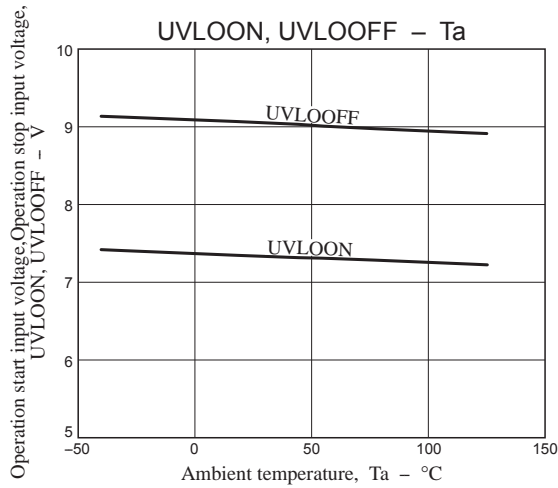
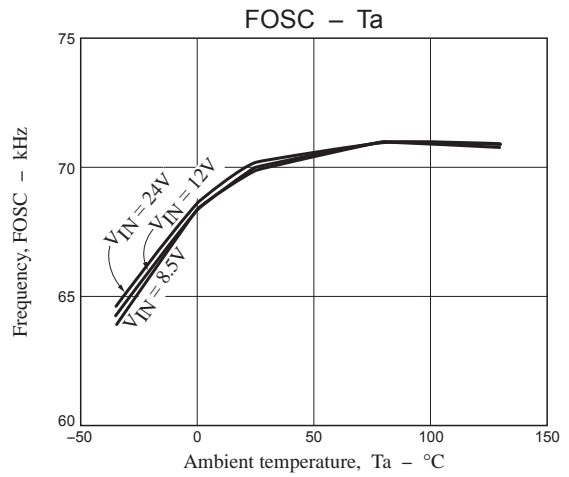
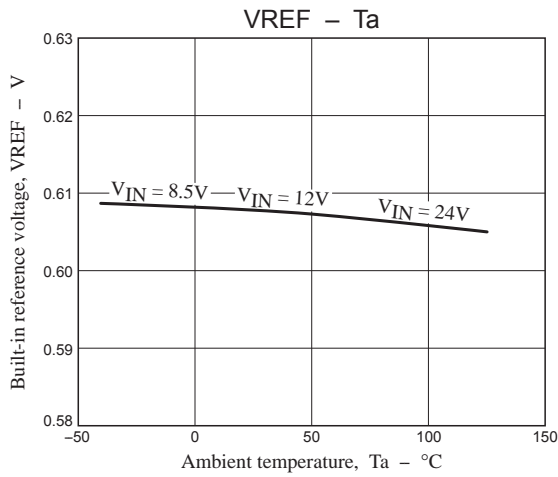


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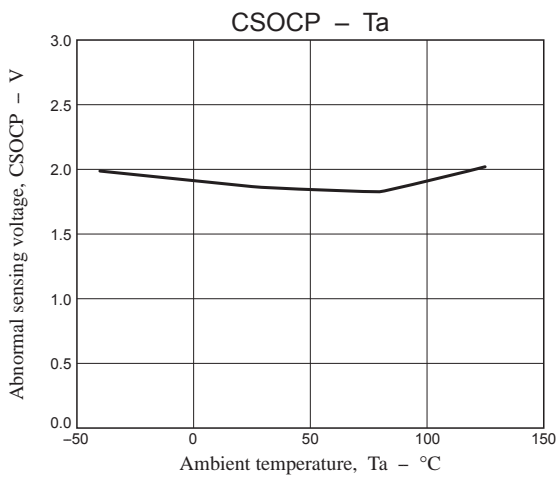
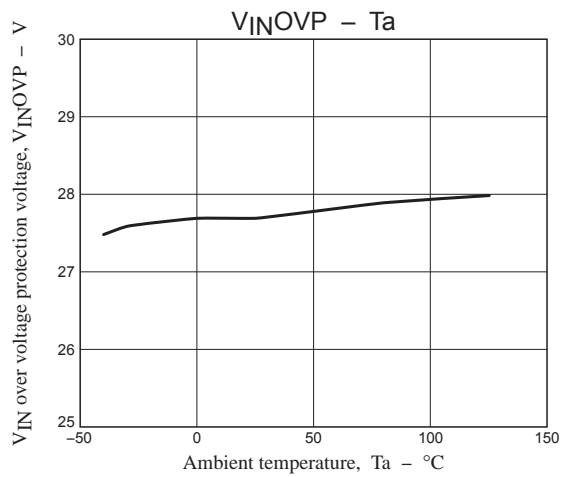
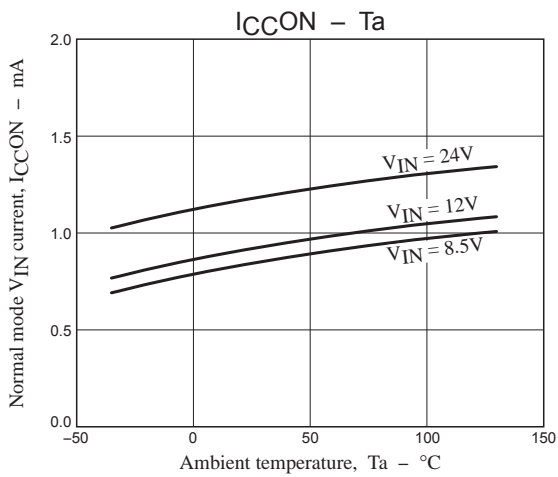
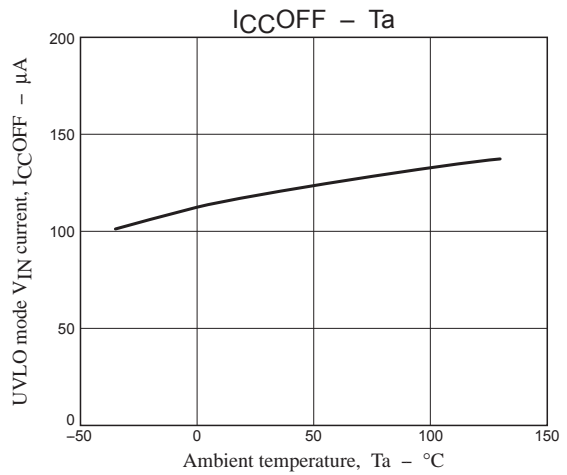
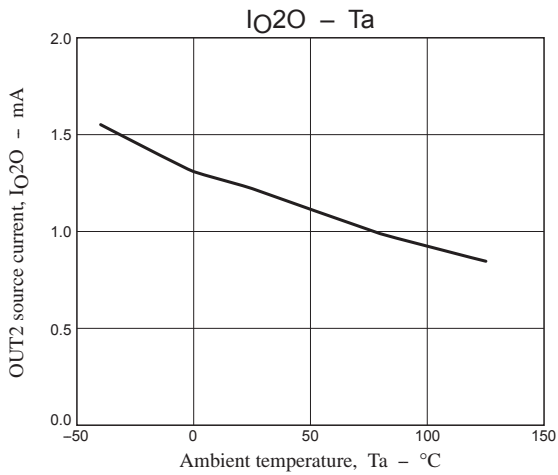
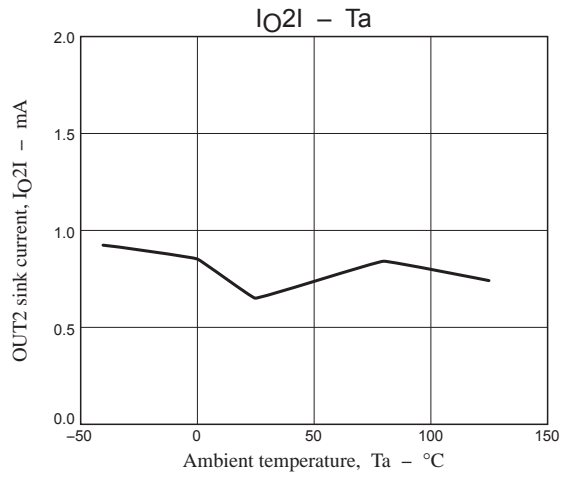
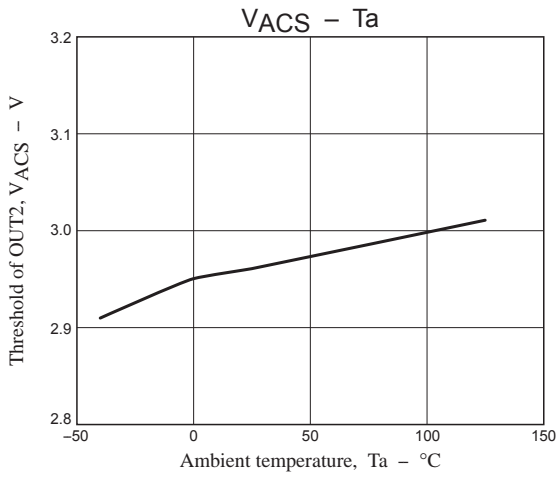
Pin Functions

| Pin No | Pin Name | Pin Function | Equivalent Circuit |
|--------|----------|---|--------------------|
| 1 | Drain | Drain pin of built-in power FET | |
| 2 | (NC) | No connect pin | |
| 3 | VIN | Power supply pin. Under voltage lock out VIN<UVLOFF(7.3V): Stop VIN>UVLOON(9V): Operation Over voltage protection VIN>VINOVP(27V): Switching Stop | |
| 4 | ACS | ACS pin senses AC Voltage. This pin is used to stabilize the TRIAC dimming application. ACS pin>3V : OUT2=Low ACS pin<3V : OUT2=High If this function isn't used, please connect GND. | |
| 5 | OUT2 | OUT2 pin drives the gate of TRIAC bleeder, which stabilizes dimming function. If dimming function not used, do not connect. If ACS is below 3V, OUT2 is high (VIN). | |
| 6 | REF_IN | External LED current limit set pin (ILimit). If pin 6 < 0.605V, then Ipeak value is used for REF_IN. If pin 6 > 0.605V, then Ipeak value is used for 0.605V (internal reference). | |
| 7 | CS | LED current sensing in. If this terminal voltage exceeds VREF (or REF_IN), external FET is OFF. And if the voltage of the terminal exceeds 1.9V, LV5011MD turns to latch-off mode. | |
| 8 | GND | GND pin | |
| 9 | (NC) | No connect pin | |
| 10 | Source | Source pin of built-in FET | |

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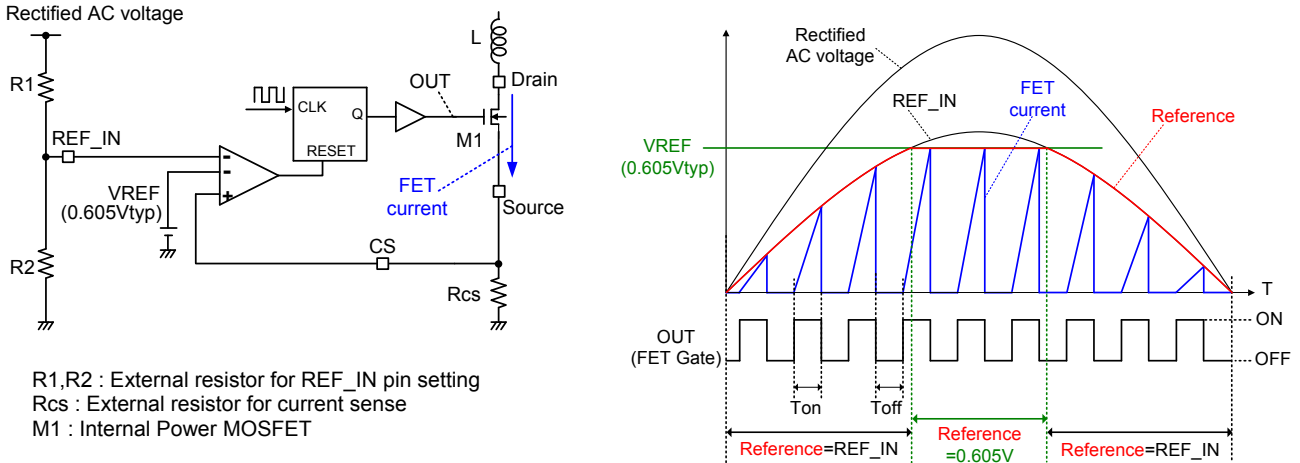


Functional description

LV5011MD is an LED driver IC that operates directly from the rectified AC voltage. LV5011MD controls brightness of the LED by controlling a peak current of the internal MOSFET.

1. Peak current control

LV5011MD detects the current of internal MOSFET as shown in the following diagram. The current that flows into MOSFET is a triangular wave shown in the diagram. The current peak value is determined by the relationship between the reference level and CS voltage. This relationship makes Power Factor Correction (PFC). CS voltage is used by internal comparator to compare to the reference level. LV5011MD controls the peak value of MOSFET current. Here, the reference level is lower value of either “REF_IN” or “VREF(0.605V)”.



The peak value of MOSFET current (I_{pk}) is determined by :

$$\text{In the case of "REF_IN < VREF(0.605V)" } \rightarrow I_{pk} = \frac{REF_IN}{Rcs}$$

$$\text{In the case of "REF_IN > VREF(0.605V)" } \rightarrow I_{pk} = \frac{0.605V}{Rcs}$$

2. Bleeder current circuit for TRIAC dimming

LV5011MD contains the bleeder current circuit for TRIAC dimming. Please connect OUT2 to the external MOSFET gate and connect the resistor “Rd” to its drain.

2-1. Operating voltage setting

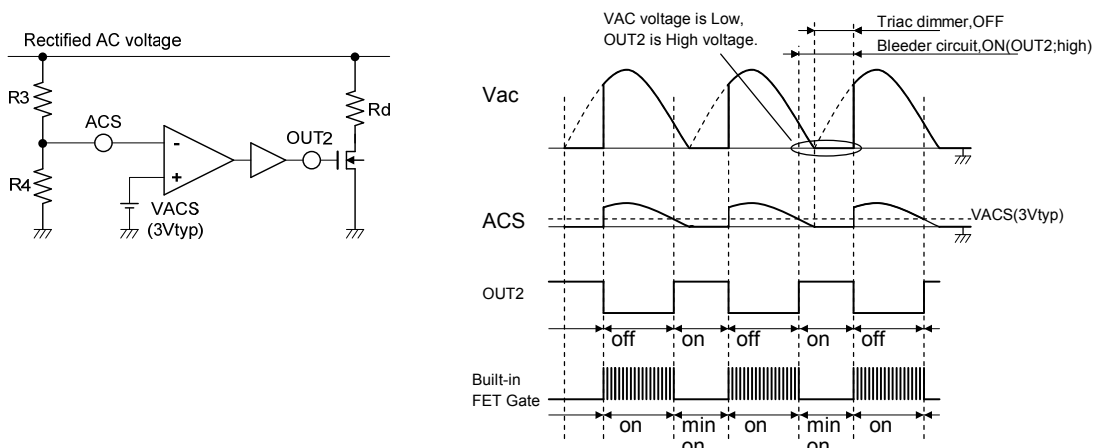
OUT2 pin is controlled by setting value on ACS pin. When ACS pin voltage is below 3V, OUT2 is high and external FET is turned on. The bleeder operation threshold of the rectified AC is determined below.

$$Vac_bleeder = \frac{R3 + R4}{R4} \times 3V$$

2-2. Bleeder current setting

Bleeder current is set by Rd. Please calculate Rd value based on TRIAC dimmer.

Waveforms diagram

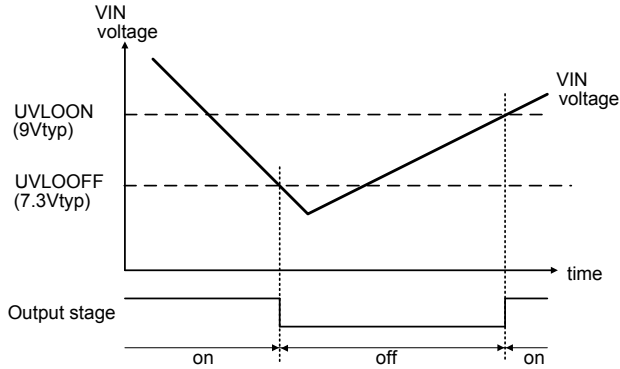


3. Protection Function

| | Tilte | outline | monitor point |
|-----|--------------|--|-------------------------|
| 3.1 | UVLO | Under Voltage Lock Out | VIN voltage |
| 3.2 | OCP | Over Current Protection | CS voltage |
| 3.3 | OVP | Over Voltage Protection | VIN voltage |
| 3.4 | OTP (TSD) | Over Temperature Protection (Thermal Shut Down) | PN Junction temperature |

3.1 UVLO(Under Voltage Lock Out)

If VIN voltage is 7.3V or lower, then UVLO operates and the IC stops. When UVLO operates, the power supply current of the IC is about 120µA or lower. If VIN voltage is 9V or higher, then the IC starts switching operation.

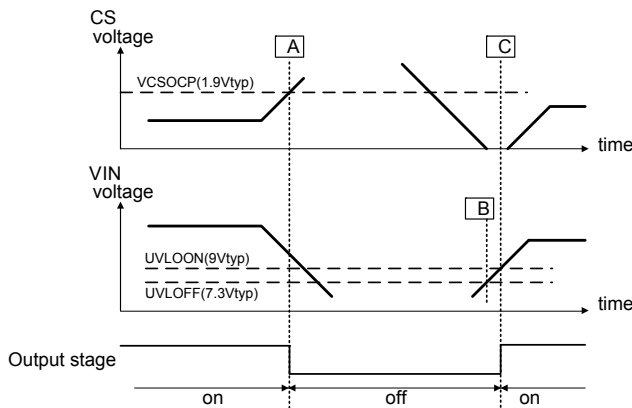


3.2 OCP(Over Current Protection)

CS pin is used to sense current in primary winding of transformer via internal HV MOSFET. This provides an additional level of protection in the event of a fault. If the voltage of the CS pin exceeds VCSOCP(1.9V typ.)(A), the internal comparator will detect the event and turn off the MOSFET. The peak switch current is calculated

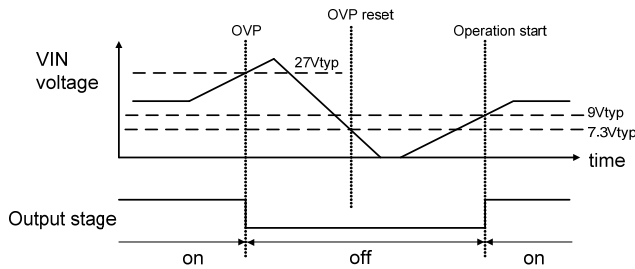
$$I_{ocp(peak)} [A] = V_{CSOCP}[V] / R_{cs}[\Omega]$$

The VIN pin is pulled down to fixed level, keeping the controller latched off. The latch reset occurs when the user disconnects LED from VAC and lets the VIN falls below the VIN reset voltage, UVLOOFF(7.3V typ.)(B). Switching restarts when VIN rises to UVLOON(9V typ.)(C).



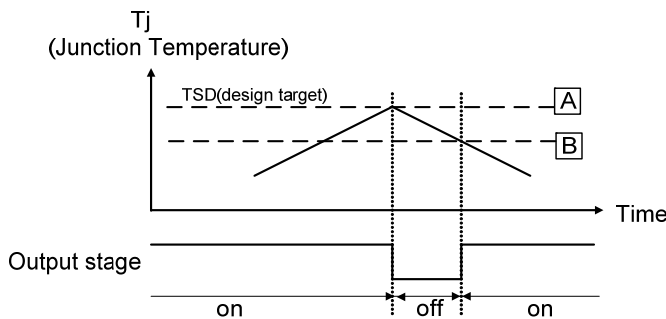
3.3 OVP(Over Voltage Protection)

If the voltage of VIN pin is higher than the internal reference voltage VINOVP(27V typ.), switching operation is stopped. The IC(device) will not restart till reset voltage <7.3V and then rise to 9V. Please see OVP waveform chart.



3.4 OTP(Over Temperature Protection)

The over temperature protection stops the switching operation of the IC in case the junction temperature reaches 165°C (typ.) (A). The IC starts switching operation again when the junction temperature is 135°C (typ.) (B) or lower. Please see OTP waveform chart.



ORDERING INFORMATION

| Device | Package | Shipping (Qty / Packing) |
|-------------|---------------------------------------|--------------------------|
| LV5011MD-AH | SOIC-10NB (Pb-Free / Halogen Free) | 2500 / Tape & Reel |

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